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Part Number:

0740401343

Status:

Active

Overview:

VHDM Backplane Connector Systems

Description:

VHDM Daughtercard, 2.00mm Pitch, 8-Rows, 25 Wafers, 200 Circuits, Tin Lead, Guide Module

Documents:

Drawing (PDF)

Product Specification PS-74031-999-001 (PDF)

Packaging Specification PK-70873-5041-001 (PDF)

RoHS Certificate of Compliance (PDF)

Agency Certification

UL

E29179

General

Product Family

Series

Application

Application Tooling Documents

Comments

Component Type

Overview

Product Name

UPC

Backplane Connectors

74040

Backplane

TM-622010999-001

Daughter Card

PCB Header

VHDM Backplane Connector Systems

VHDM

883906551841

Physical

Circuits (Loaded)

Circuits (maximum)

Color - Resin

Durability (mating cycles max)

First Mate / Last Break

Flammability

Guide to Mating Part

Keying to Mating Part

Material - Metal

Material - Plating Mating

Material - Plating Termination

Material - Resin

Net Weight

Number of Columns

Number of Pairs

Number of Rows

Orientation

PC Tail Length

PCB Locator

PCB Retention

PCB Thickness - Recommended

Packaging Type

Pitch - Mating Interface

Plating min - Mating

Polarized to PCB

Stackable

Surface Mount Compatible (SMC)

Temperature Range - Operating

Termination Interface: Style

200

200

Black

200

No

94V-0

Yes

N/A

Copper Alloy

Gold

Matte Tin

High Performance Thermoplastic

59.065/g

25

N/A

8

Right Angle

2.80mm

No

None

1.80mm

Tube

2.00mm

0.762µm

No

Yes

Yes

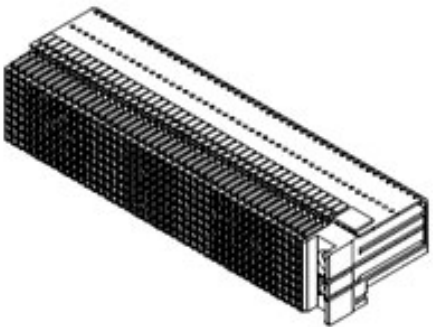
-55° to +80°C

Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact

1.0A



Series image - Reference only

EU ELV

Not Relevant

EU RoHS

Compliant

China RoHS

REACH SVHC

Not Contained Per -
D(2021)4569-DC (8
July 2021)

Halogen-Free

Status

Low-Halogen

For more information, please visit [Contact US](#)

China ROHS

Green Image

ELV

Not Relevant

RoHS Phthalates

Not Contained

Search Parts in this Series

74040 Series

Application Tooling | [FAQ](#)

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description

Product #

Card Stiffener

622016200

Removal Tool

Data Rate	3.125 Gbps
Shielded	Yes
Voltage - Maximum	120V AC (RMS)/DC
Solder Process Data	
Lead-freeProcess Capability	N/A
Material Info	
Reference - Drawing Numbers	
Packaging Specification	PK-70873-5041-001
Product Specification	PS-74031-999-001

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